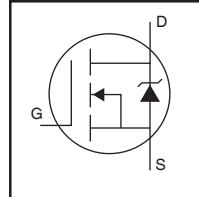


AUURLZ44Z

HEXFET® Power MOSFET

Features

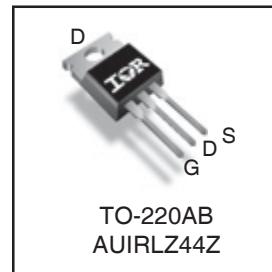
- Advanced Process Technology
- Ultra Low On-Resistance
- 175°C Operating Temperature
- Fast Switching
- Repetitive Avalanche Allowed up to T_{jmax}
- Lead-Free, RoHS Compliant
- Automotive Qualified *



$V_{(BR)DSS}$	55V
$R_{DS(on)}$	typ. 11mΩ
	max. 13.5mΩ
I_D	51A

Description

Specifically designed for Automotive applications, this HEXFET® Power MOSFET utilizes the latest processing techniques to achieve extremely low on-resistance per silicon area. Additional features of this design are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating. These features combine to make this design an extremely efficient and reliable device for use in Automotive applications and a wide variety of other applications.



G	D	S
Gate	Drain	Source

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	51	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	36	
I_{DM}	Pulsed Drain Current ^①	204	
$P_D @ T_C = 25^\circ C$	Power Dissipation	80	W
	Linear Derating Factor	0.53	W/°C
V_{GS}	Gate-to-Source Voltage	± 16	V
$E_{AS(\text{Thermally Limited})}$	Single Pulse Avalanche Energy ^②	78	mJ
$E_{AS(\text{tested})}$	Single Pulse Avalanche Energy Tested Value ^③	110	
I_{AR}	Avalanche Current ^④	See Fig.12a, 12b, 15, 16	A
E_{AR}	Repetitive Avalanche Energy ^⑤		mJ
T_J	Operating Junction and	-55 to + 175	°C
T_{STG}	Storage Temperature Range		
	Soldering Temperature, for 10 seconds (1.6mm from case)		
	Mounting Torque, 6-32 or M3 screw	300	
		10 lbf·in (1.1N·m)	

Thermal Resistance

	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case ^⑦	—	1.87	°C/W
$R_{\theta CS}$	Case-to-Sink, Flat Greased Surface	0.50	—	
$R_{\theta JA}$	Junction-to-Ambient	—	62	

HEXFET® is a registered trademark of International Rectifier.

*Qualification standards can be found at <http://www.irf.com/>

Static Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{DSS}}$	Drain-to-Source Breakdown Voltage	55	—	—	V
$\Delta V_{(\text{BR})\text{DSS}}/\Delta T_J$	Breakdown Voltage Temp. Coefficient	—	0.05	—	V/ $^\circ\text{C}$
$R_{\text{DS}(\text{on})}$	Static Drain-to-Source On-Resistance	—	11	13.5	$\text{m}\Omega$
		—	—	20	$\text{m}\Omega$
		—	—	22.5	$\text{m}\Omega$
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	1.0	—	3.0	V
g_{fs}	Forward Transconductance	27	—	—	V
I_{DSS}	Drain-to-Source Leakage Current	—	—	20	μA
		—	—	250	
I_{GSS}	Gate-to-Source Forward Leakage	—	—	200	nA
	Gate-to-Source Reverse Leakage	—	—	-200	

Dynamic Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

Parameter	Min.	Typ.	Max.	Units	Conditions
Q_g	Total Gate Charge	—	24	36	nC
Q_{gs}	Gate-to-Source Charge	—	7.5	—	
Q_{gd}	Gate-to-Drain ("Miller") Charge	—	12	—	
$t_{d(\text{on})}$	Turn-On Delay Time	—	14	—	ns
t_r	Rise Time	—	160	—	
$t_{d(\text{off})}$	Turn-Off Delay Time	—	25	—	
t_f	Fall Time	—	42	—	
L_D	Internal Drain Inductance	—	4.5	—	nH
L_S	Internal Source Inductance	—	7.5	—	
C_{iss}	Input Capacitance	—	1620	—	pF
C_{oss}	Output Capacitance	—	230	—	
C_{rss}	Reverse Transfer Capacitance	—	130	—	
C_{oss}	Output Capacitance	—	860	—	
C_{oss}	Output Capacitance	—	180	—	
$C_{oss \text{ eff.}}$	Effective Output Capacitance	—	280	—	

Diode Characteristics

Parameter	Min.	Typ.	Max.	Units	Conditions
I_S	Continuous Source Current (Body Diode)	—	—	51	A
I_{SM}	Pulsed Source Current (Body Diode) ①	—	—	204	
V_{SD}	Diode Forward Voltage	—	—	1.3	V
t_{rr}	Reverse Recovery Time	—	21	32	ns
Q_{rr}	Reverse Recovery Charge	—	16	24	nC
t_{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)			

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11).
- ② Limited by $T_{J\text{max}}$, starting $T_J = 25^\circ\text{C}$, $L = 0.166\text{mH}$ $R_G = 25\Omega$, $I_{AS} = 31\text{A}$, $V_{GS} = 10\text{V}$. Part not recommended for use above this value.
- ③ Pulse width $\leq 1.0\text{ms}$; duty cycle $\leq 2\%$.
- ④ $C_{oss \text{ eff.}}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} .
- ⑤ Limited by $T_{J\text{max}}$, see Fig.12a, 12b, 15, 16 for typical repetitive avalanche performance.
- ⑥ This value determined from sample failure population, starting $T_J = 25^\circ\text{C}$, $L = 0.166\text{mH}$, $R_G = 25\Omega$, $I_{AS} = 31\text{A}$, $V_{GS} = 10\text{V}$.
- ⑦ R_θ is measured at T_J approximately 90°C .

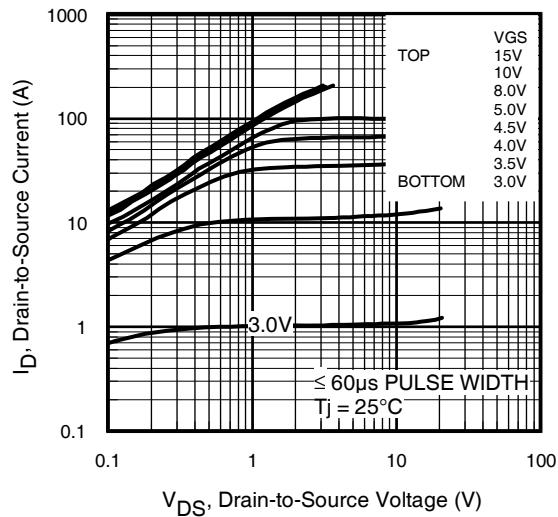
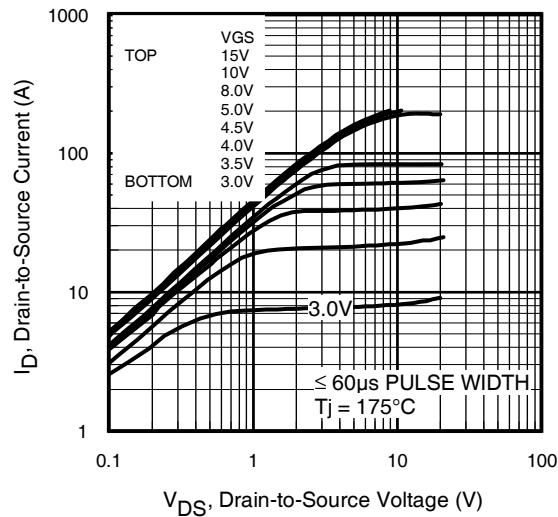
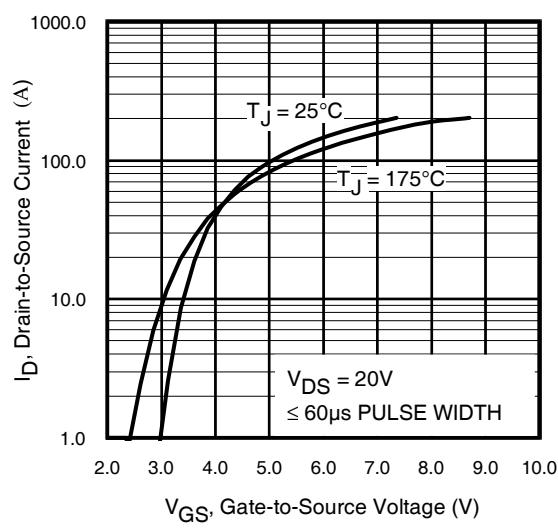
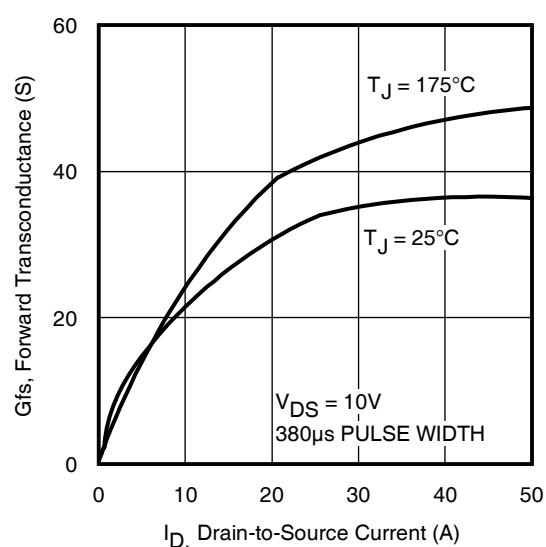
Qualification Information[†]

		Automotive (per AEC-Q101) ^{††}	
Qualification Level		Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.	
Moisture Sensitivity Level		TO-220AB	N/A
ESD	Machine Model	Class M4(+/- 425V) ^{†††} (per AEC-Q101-002)	
	Human Body Model	Class H1C(+/- 2000V) ^{†††} (per AEC-Q101-001)	
	Charged Device Model	Class C5(+/- 1125V) ^{†††} (per AEC-Q101-005)	
RoHS Compliant		Yes	

[†] Qualification standards can be found at International Rectifier's web site: <http://www.irf.com/>

^{††} Exceptions to AEC-Q101 requirements are noted in the qualification report.

^{†††} Highest passing voltage

**Fig 1.** Typical Output Characteristics**Fig 2.** Typical Output Characteristics**Fig 3.** Typical Transfer Characteristics**Fig 4.** Typical Forward Transconductance Vs. Drain Current

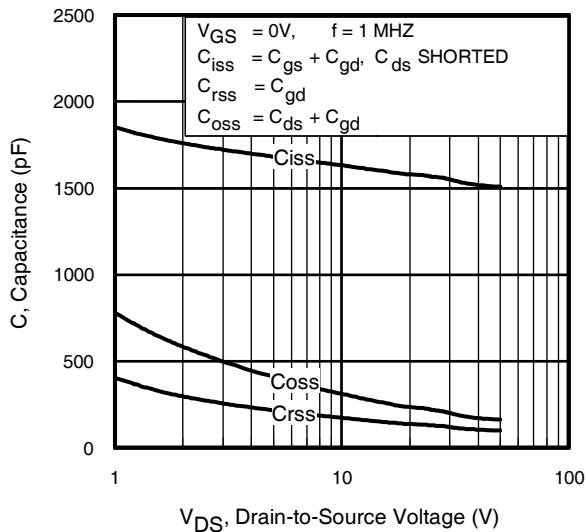


Fig 5. Typical Capacitance Vs.
Drain-to-Source Voltage

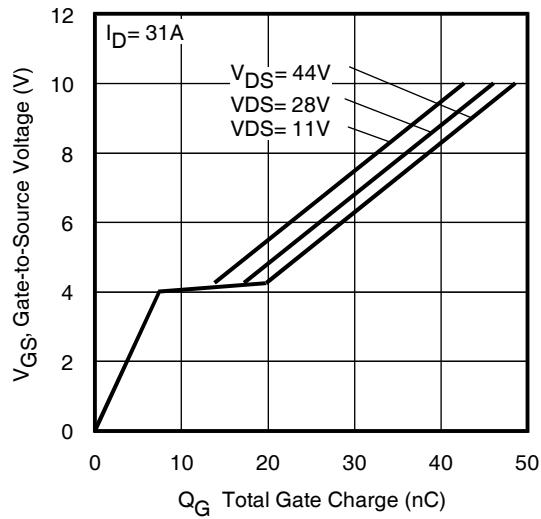


Fig 6. Typical Gate Charge Vs.
Gate-to-Source Voltage

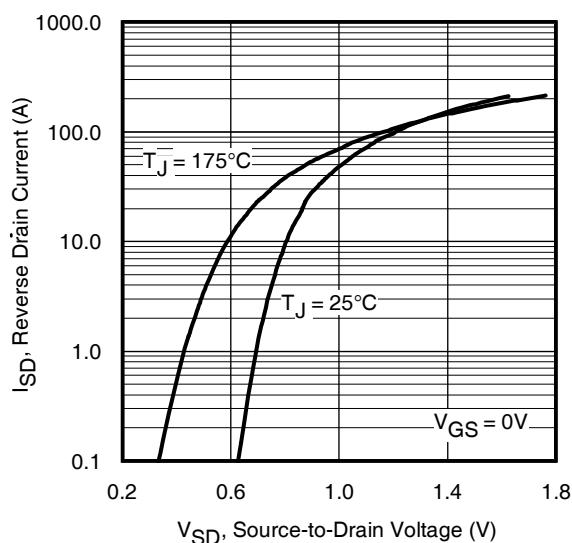


Fig 7. Typical Source-Drain Diode
Forward Voltage

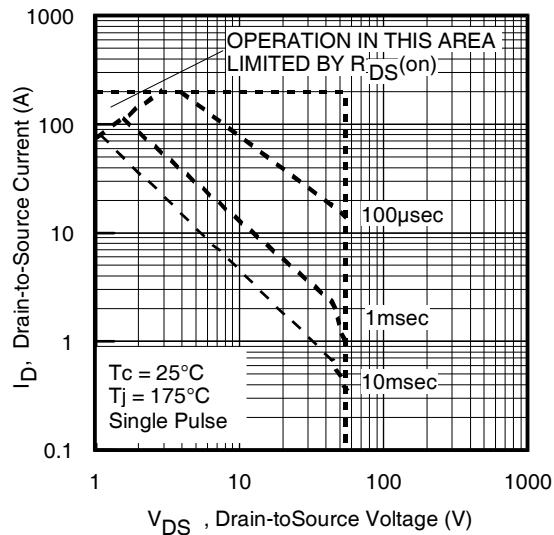


Fig 8. Maximum Safe Operating Area

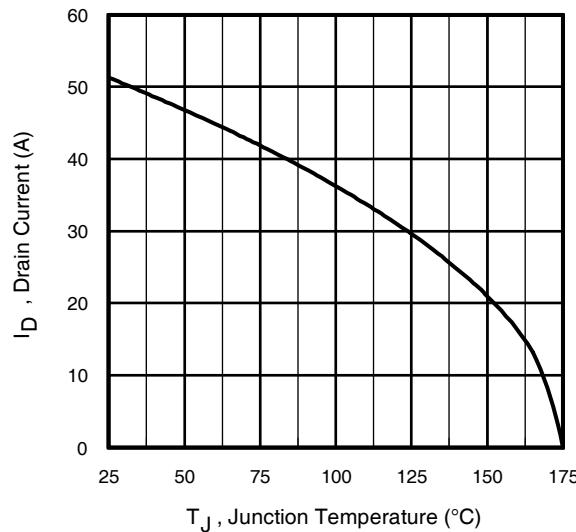


Fig 9. Maximum Drain Current Vs.
Case Temperature

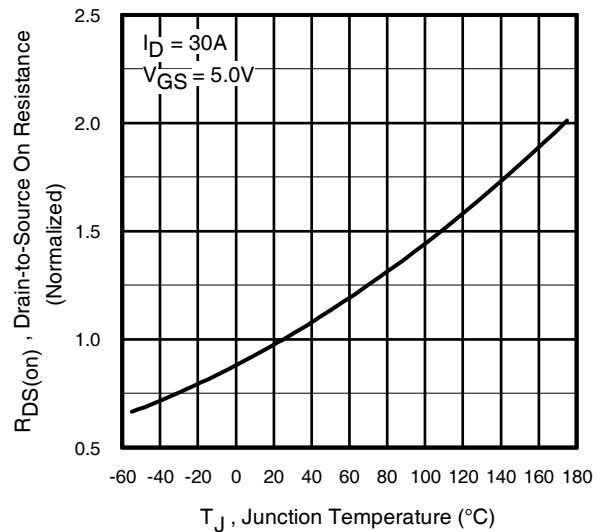


Fig 10. Normalized On-Resistance
Vs. Temperature

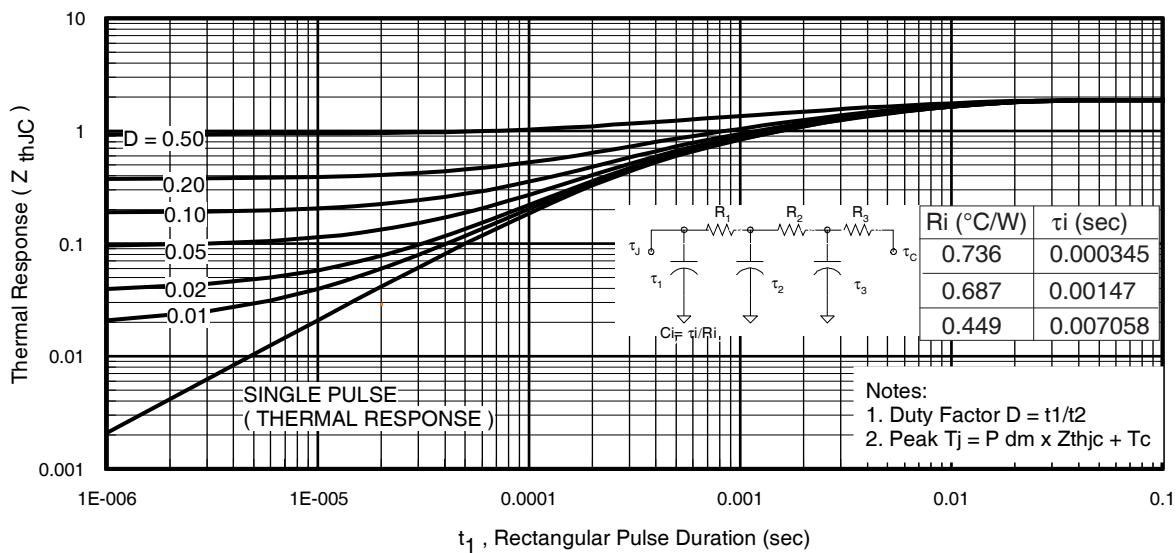


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

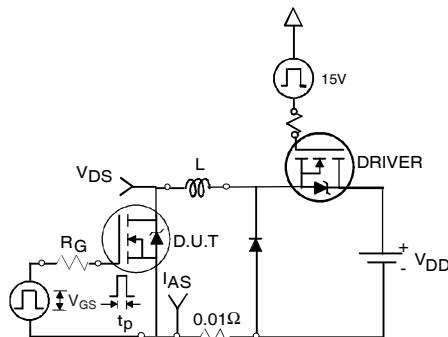


Fig 12a. Unclamped Inductive Test Circuit

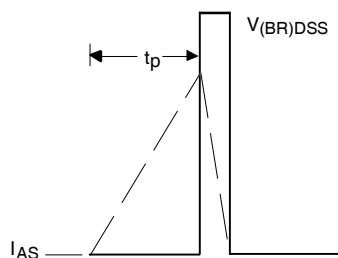


Fig 12b. Unclamped Inductive Waveforms

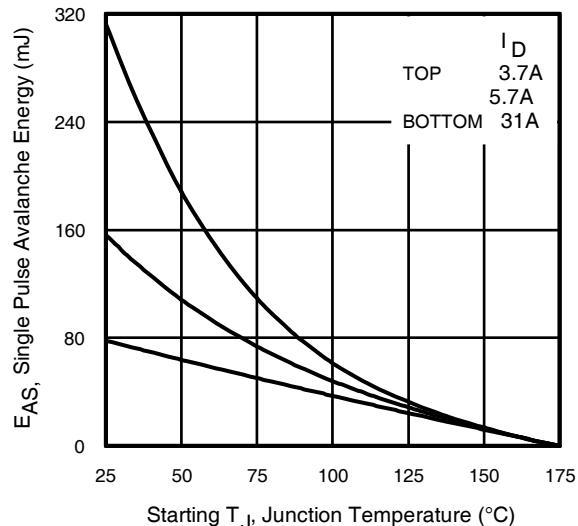


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

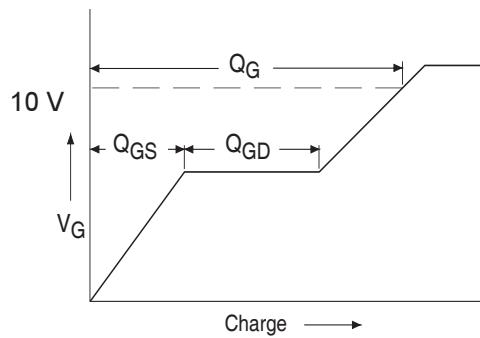


Fig 13a. Basic Gate Charge Waveform

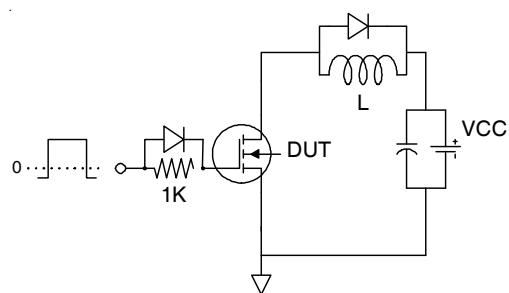


Fig 13b. Gate Charge Test Circuit
www.irf.com

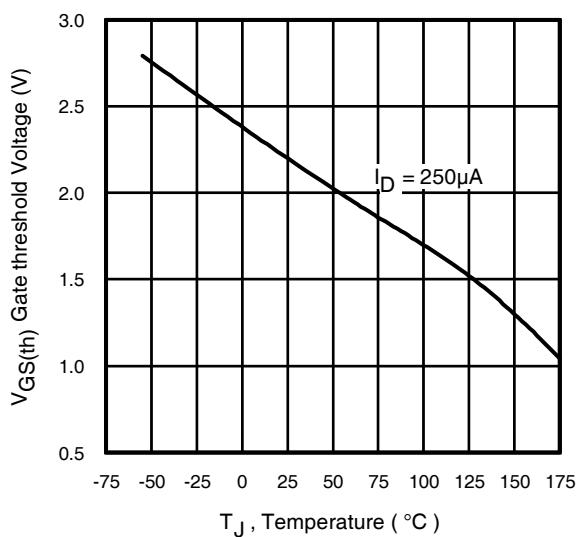
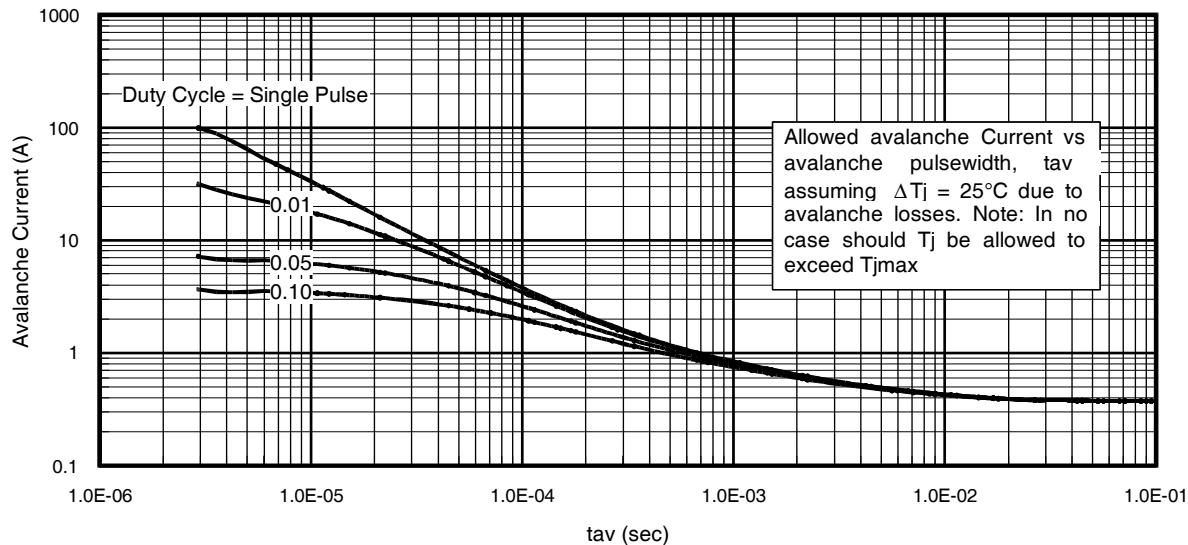
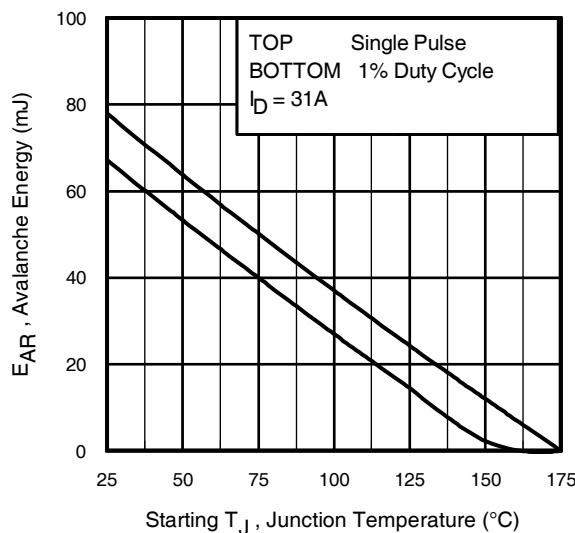


Fig 14. Threshold Voltage Vs. Temperature

**Fig 15.** Typical Avalanche Current Vs.Pulsewidth

Notes on Repetitive Avalanche Curves , Figures 15, 16:
(For further info, see AN-1005 at www.irf.com)

1. Avalanche failures assumption:
Purely a thermal phenomenon and failure occurs at a temperature far in excess of T_{jmax} . This is validated for every part type.
2. Safe operation in Avalanche is allowed as long as T_{jmax} is not exceeded.
3. Equation below based on circuit and waveforms shown in Figures 12a, 12b.
4. $P_{D \text{ (ave)}}$ = Average power dissipation per single avalanche pulse.
5. BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
6. I_{av} = Allowable avalanche current.
7. ΔT = Allowable rise in junction temperature, not to exceed T_{jmax} (assumed as 25°C in Figure 15, 16).
- t_{av} = Average time in avalanche.
- D = Duty cycle in avalanche = $t_{av} \cdot f$
- $Z_{thJC}(D, t_{av})$ = Transient thermal resistance, see figure 11)

$$P_{D \text{ (ave)}} = 1/2 (1.3 \cdot BV \cdot I_{av}) = \Delta T / Z_{thJC}$$

$$I_{av} = 2\Delta T / [1.3 \cdot BV \cdot Z_{th}]$$

$$E_{AS \text{ (AR)}} = P_{D \text{ (ave)}} \cdot t_{av}$$

Fig 16. Maximum Avalanche Energy
Vs. Temperature

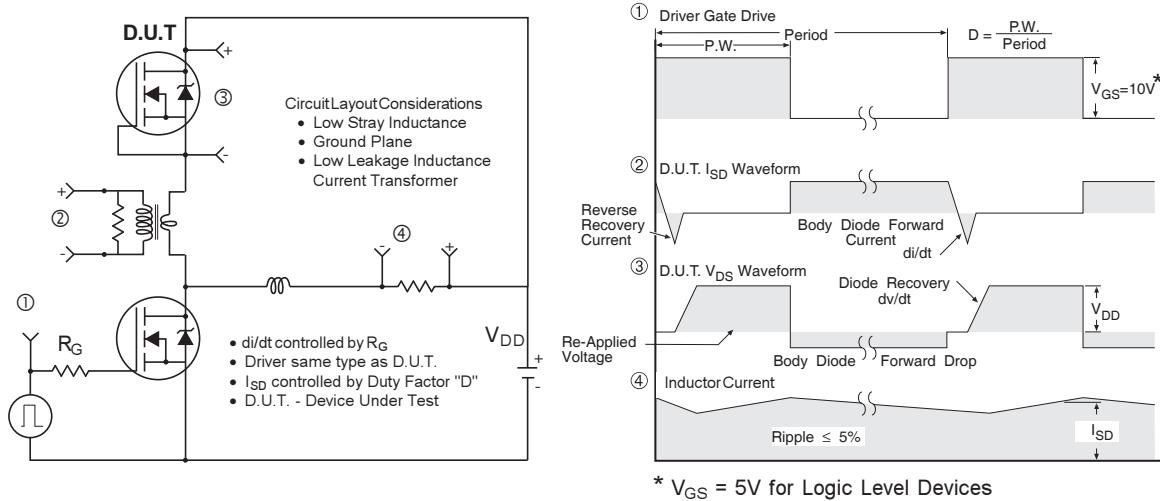


Fig 17. Diode Reverse Recovery Test Circuit for N-Channel HEXFET® Power MOSFETs

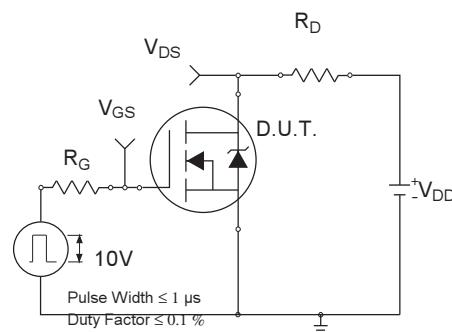


Fig 18a. Switching Time Test Circuit

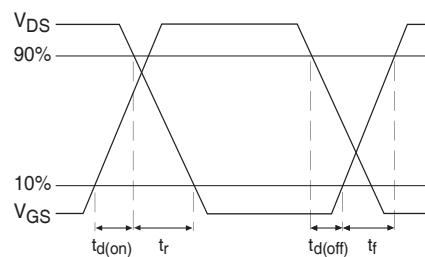
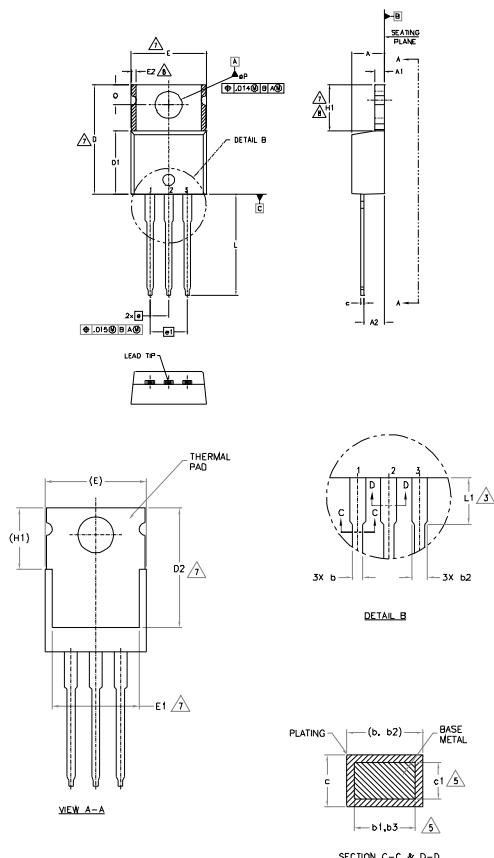


Fig 18b. Switching Time Waveforms

TO-220AB Package Outline

Dimensions are shown in millimeters (inches)



NOTES:

- 1.- DIMENSIONING AND TOLERANCING AS PER ASME Y14.5 M- 1994.
- 2.- DIMENSIONS ARE SHOWN IN INCHES [MILLIMETERS].
- 3.- LEAD LENGTH AND FINISH UNCONTROLLED IN L1.
- 4.- DIMENSION D, D1 & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .006 (.152) PER SIDE. THESE DIMENSIONS ARE MEASURED FROM THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
- 5.- DIMENSION b1, b3 & c1 APPLY TO BASE METAL ONLY.
- 6.- CONTROLLING DIMENSION - INCHES.
- 7.- THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS E1, D2 & E1.
- 8.- DIMENSION E2 X H1 DEFINE A Z ZONE WHERE STAMPING AND SINGULATION IRREGULARITIES ARE ALLOWED.
- 9.- OUTLINE CONFORMS TO JEDEC TO-220, EXCEPT A2 (max.) AND D2 (min.) WHERE DIMENSIONS ARE DERIVED FROM THE ACTUAL PACKAGE OUTLINE.

SYMBOL	DIMENSIONS		NOTES
	MILLIMETERS	INCHES	
	MIN.	MAX.	
A	3.56	4.83	.140 .190
A1	0.51	1.40	.020 .065
A2	2.03	2.92	.080 .115
b	0.38	1.01	.015 .040
b1	0.38	0.97	.015 .038
b2	1.14	1.78	.045 .070
b3	1.14	1.73	.045 .068
c	0.36	0.61	.014 .024
c1	0.36	0.56	.014 .022
D	14.22	16.51	.560 .650
D1	8.38	9.02	.330 .355
D2	11.68	12.88	.460 .507
E	9.65	10.67	.380 .420
E1	6.86	8.89	.270 .350
E2	-	0.76	- .030
e	2.54 BSC 5.08 BSC	1.00 BSC 2.00 BSC	
e1	5.84	6.86	.230 .270
H1	12.70	14.73	.500 .580
L	3.56	4.06	.140 .160
L1	3.54	4.08	.139 .161
eP	3.54	4.08	.100 .135
Q	2.54	3.42	

LEAD ASSIGNMENTS

- HEXFET
- 1- GATE
 - 2- DRAIN
 - 3- SOURCE

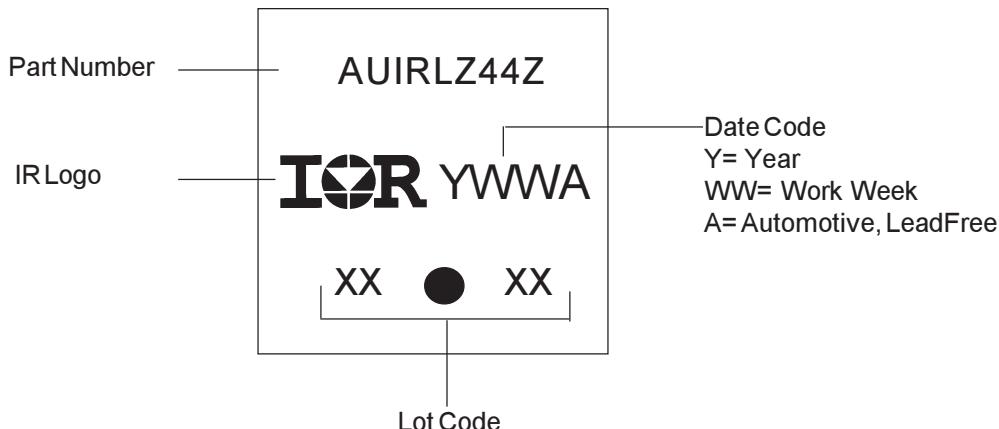
DIGITAL CAPACK

- 1- GATE
- 2- COLLECTOR
- 3- Emitter

DIODES

- 1- ANODE
- 2- CATHODE
- 3- ANODE

TO-220AB Part Marking Information



TO-220AB packages are not recommended for Surface Mount Application.

Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

Ordering Information

Base part number	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUURLZ44Z	TO-220	Tube	50	AUURLZ44Z

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